

# 2SJ360-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY							
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)				
- 60	0.058 at V <sub>GS</sub> = - 10 V	- 6.5	30 nC				
	0.065 at V <sub>GS</sub> = - 4.5 V	- 5.5	30110				

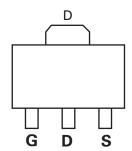
#### **FEATURES**

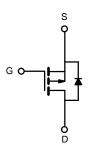
- TrenchFET® Power MOSFET
- 100 % UIS Tested

#### **APPLICATIONS**

Load Switch







P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 60	.,	
Gate-Source Voltage	$V_{GS}$	± 20	V	
	T <sub>C</sub> = 25 °C		- 6.5 <sup>a</sup>	
Continuous Prain Current (T = 150 °C)	T <sub>C</sub> = 70 °C		- 5.2	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.8 <sup>b</sup>	A
	T <sub>A</sub> = 70 °C		- 4.1 <sup>b</sup>	A
Pulsed Drain Current	I <sub>DM</sub>	- 20		
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	- 4.5	7
Single Pulse Avalanche Energy	L = 0.1 IIII	E <sub>AS</sub>	10.1	mJ
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	6.9 <sup>a</sup>	А
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.5 <sup>b</sup>	A
	T <sub>C</sub> = 25 °C		10.4 <sup>a</sup>	
Manifestor Brown Binding the	T <sub>C</sub> = 70 °C		6.6 <sup>a</sup>	10/
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub> —	2.1 <sup>b</sup>	W
	T <sub>A</sub> = 70 °C		1.1 <sup>b</sup>	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS								
Parameter	Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	33	40	°C/W			
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.98	1.2	- C/VV			

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		68		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_{J}$	1 <sub>D</sub> = - 200 μΛ		- 5.2		IIIV/ C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.2		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zana Cata Valta na Busin Commant	1	V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V			- 1	^
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 25			Α
	_	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3 A		0.058		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2 A		0.065		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A	20			S
Dynamic <sup>b</sup>			L		L	
Input Capacitance	C <sub>iss</sub>			1500		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		200		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			150		
Total Oats Observe	Qg	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -5 \text{ A}$		38	56	nC
Total Gate Charge				19	30	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5 \text{ A}$		9		
Gate-Drain Charge	$Q_{gd}$			10		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		5.2		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	
Rise Time	t <sub>r</sub>	$V_{DD} = -2 V, R_L = 2 \Omega$		7	15	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		70	110	
Fall Time	t <sub>f</sub>			40	60	
<b>Drain-Source Body Diode Characteristic</b>	s		L	1	L	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 6.9	А
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 15	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A		- 1	- 1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			45	68	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	F A di/d+ 40 A/22 T 05 22		59	120	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -5 \text{ A}, \text{ di/dt} = 10 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		29		
Reverse Recovery Rise Time	t <sub>b</sub>			16		ns

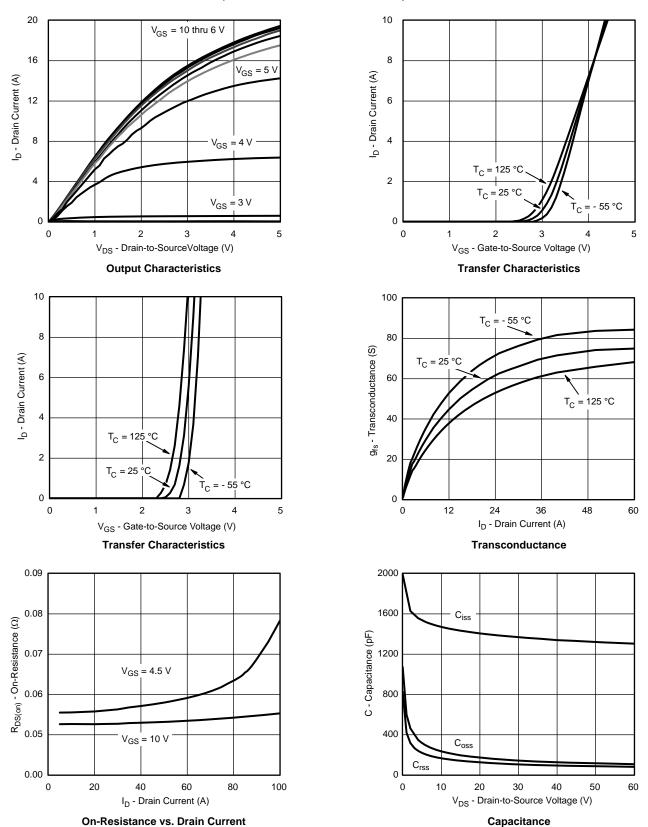
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

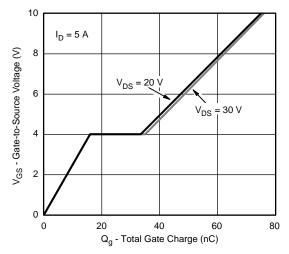


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

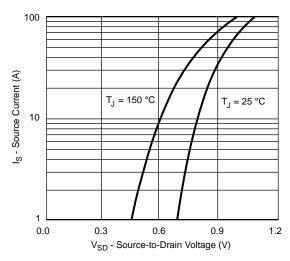




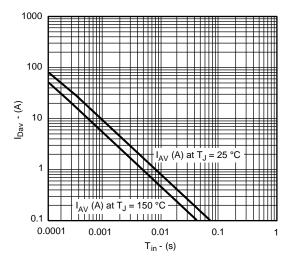
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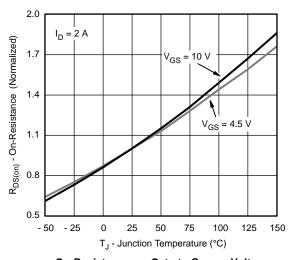




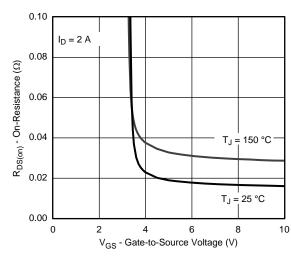
Source-Drain Diode Forward Voltage



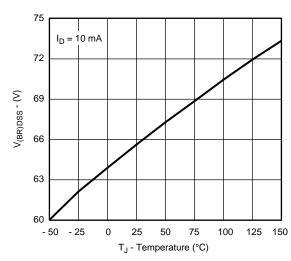
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



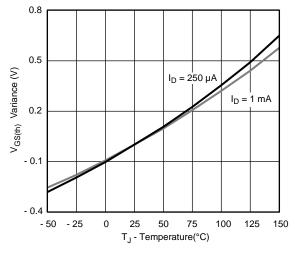
On-Resistance vs. Gate-to-Source Voltage

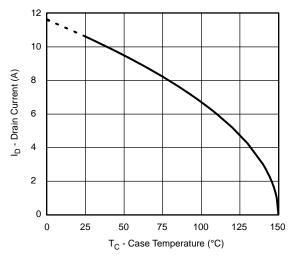


Drain-Source Breakdown Voltage vs. Junction Temperature

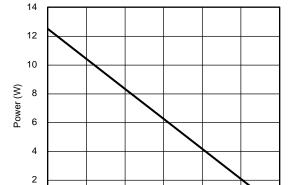


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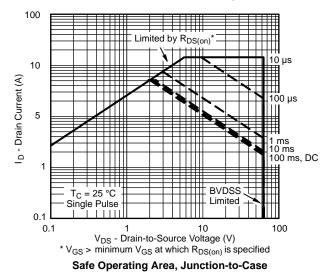




Threshold Voltage



Max. Drain Current vs. Case Temperature



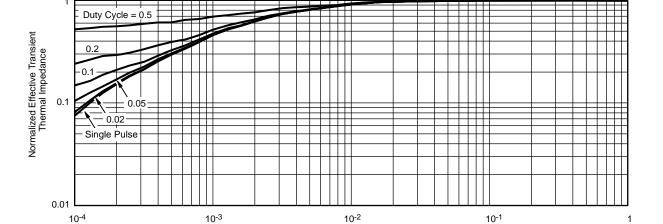
 $\label{eq:TJ-Temperature condition} T_J \text{ - Temperature (°C)}$  Power Derating, Junction-to-Case

75

100

125

150



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

0

0

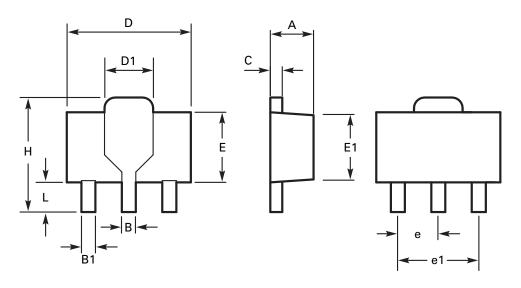
25

50

5



## Package outline - SOT89



DIM	Millimeters		Inc	Inches DIM Millimeters I		Inches DIN		Millimeters		Inc	hes
	Min	Max	Min	Max		Min	Max	Min	Max		
Α	1.40	1.60	0.550	0.630	Е	2.29	2.60	0.090	0.102		
В	0.44	0.56	0.017	0.022	E1	2.13	2.29	0.084	0.090		
B1	0.36	0.48	0.014	0.019	е	1.50 BSC		0.059 BSC			
С	0.35	0.44	0.014	0.017	e1	3.00 BSC		0.118 BSC			
D	4.40	4.60	0.173	0.181	Н	3.94	4.25	0.155	0.167		
D1	1.62	1.83	0.064	0.072	L	0.89	1.20	0.035	0.047		

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches



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